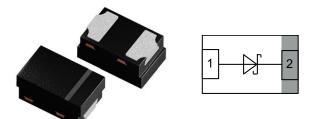
# BAS40LTH

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**Vishay Semiconductors** 

# Small Signal Schottky Diode with T<sub>J</sub> max. = 175 °C



### LINKS TO ADDITIONAL RESOURCES

SPICE 30 3D Models Models

#### **MECHANICAL DATA**

Case: DFN1006-2A

Weight: 0.83 mg

Molding compound flammability rating: UL 94 V-0

Terminals: high temperature soldering guaranteed: Peak temperature max. 260 °C

#### Packaging codes/options:

08/10K per 7" reel (8 mm tape)

### **FEATURES**

- • T<sub>.1</sub> max. = 175 °C, rated for high temperature, Available mission critical applications
- This device is protected by a PN junction guard ring against excessive voltage, such as electrostatic discharges
- Leadless ultra small DFN1006-2A package  $(1 \text{ mm} \times 0.6 \text{ mm} \times 0.45 \text{ mm})$
- Power dissipation better than SOT-23
- Surface-mounted device (SMD) plastic package with visible and sidewall plated / wettable flanks
- RoHS COMPLIANT HALOGEN FREE GREEN (5-2008)
- Soldering can be checked by standard visual inspection. No X-ray inspection necessary to meet automotive AOI requirements
- AEC-Q101 qualified available
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

PARTS TABLE							
PART	ORDERING CODE	AEC-Q101 QUALIFIED	CIRCUIT CONFIGURATION	TYPE MARKING	REMARKS		
BAS40LTH	BAS40LTH-G3-08	no	Single	GE	Tapa and real		
	BAS40LTH-HG3-08	yes	Single	GE	Tape and reel		

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	AMETER TEST CONDITION		VALUE	UNIT	
Reverse voltage		V <sub>R</sub> 40		V	
Forward current	on FR-4 board with recommended soldering footprint	١ <sub>F</sub>	200	mA	
	$T_{\rm J} = 25 \ ^{\circ}{\rm C}, t_{\rm p} = 10 \ {\rm ms}$		500	mA	
Non-repetitive peak forward current	T <sub>J</sub> = 100 °C, t <sub>p</sub> = 10 ms	I <sub>FSM</sub>	200		
	T <sub>J</sub> = 125 °C, t <sub>p</sub> = 20 μs		500		
Power dissipation	on FR-4 board with recommended soldering footprint	р	350	mW	
	R <sub>thJL</sub> = 100 K/W	P <sub>tot</sub> 1500		mW	

<b>THERMAL CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL VALUE		UNIT		
Thermal resistance junction to ambient air	Inction to ambient air according to JEDEC <sup>®</sup> 51-3 on FR-4 board with recommended soldering footprint R <sub>thJA</sub>		420	K/W		
Thermal resistance junction to lead		R <sub>thJL</sub>	100	K/W		
Maximum junction temperature		T <sub>j max.</sub>	175	°C		
Storage temperature range		T <sub>stg</sub>	-55 to +175	°C		
Operating temperature range		T <sub>op</sub>	-55 to +175	°C		

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ISHA

# **BAS40LTH**

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ELECTRICAL CHARACTERISTICS (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
	$V_{R} = 40 \text{ V}, \text{ T}_{J} = 25 ^{\circ}\text{C}$				10	μA
Leakage current	$V_R = 30 V, T_J = 150 \ ^\circ C$	I <sub>R</sub>			200	μA
	$V_{R} = 40 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$				500	μA
	I <sub>F</sub> = 1 mA				400	mV
Forward voltage	I <sub>F</sub> = 10 mA	V <sub>F</sub>			560	mV
	I <sub>F</sub> = 40 mA				1000	mV
Diode capacitance	$V_R = 0 V, f = 1 MHz$	CD		2.9		pF

### TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

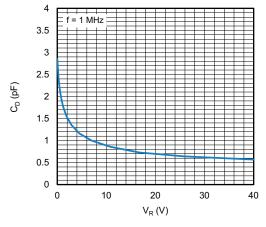


Fig. 1 - Typical Capacitance vs. Reverse Voltage

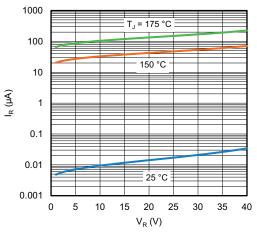


Fig. 3 - Typical Reverse Leakage Current vs. Reverse Voltage

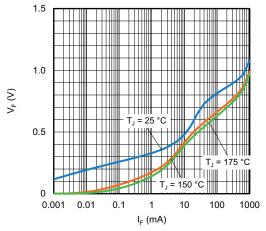


Fig. 2 - Typical Forward Voltage vs. Forward Current

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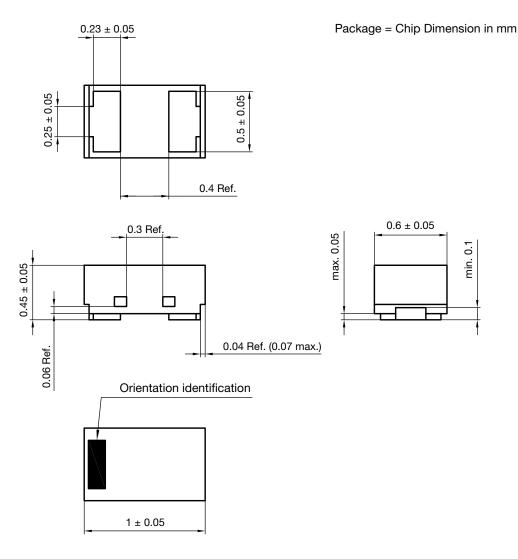
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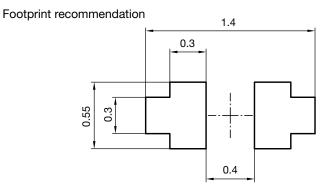
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### PACKAGE DIMENSIONS in millimeters: DFN1006-2A





Document no.: S8-V-3906.04-059 (4) Created - Date: 11-Jul-2018 Rev.5 - Date: 17-Sep-2021

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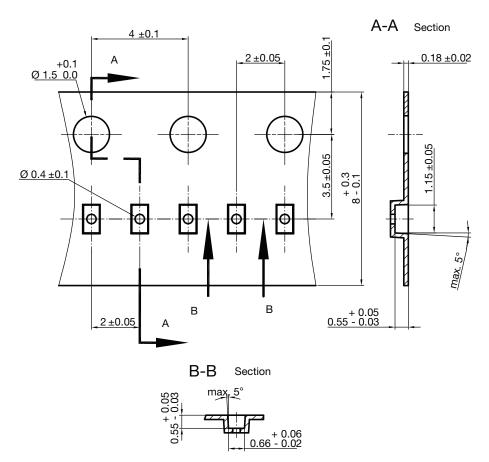
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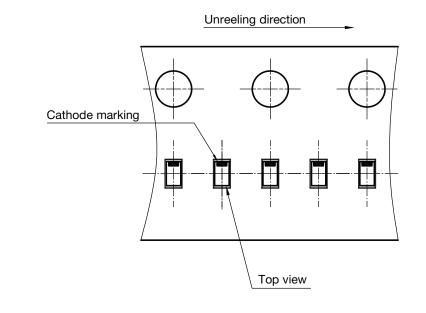


### **CARRIER TAPE DFN1006-2A**



S8-V-3906.04-063 (4) created 28.10.2019 surface resistance:  $10^5 - 10^{11} \frac{OHMS}{SQ}$ Cummulative tolerances of 10 sprocket holes is ± 0.2 mm

### **ORIENTATION IN CARRIER TAPE DFN1006-2A**



S8-V-3906.04-064 (4) created 28.10.2019

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Revision: 01-Jan-2025

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